Integrated Load Switch

FDC6329L

Description

This device is particularly suited for compact power management in portable electronic equipment where 2.5 V to 8 V input and 2.5 A output current capability are needed. This load switch integrates a small N–Channel power MOSFET (Q1) which drives a large P–Channel power MOSFET (Q2) in one tiny SUPERSOTTM–6 package.

Features

- $V_{DROP} = 0.20 \text{ V} @ V_{IN} = 5 \text{ V}, I_L = 2.8 \text{ A}, R_{(on)} = 0.07 \Omega$
- $V_{DROP} = 0.20 \text{ V}$ @ $V_{IN} = 2.5 \text{ V}$, $I_L = 1.9 \text{ A}$, $R_{(on)} = 0.105 \Omega$
- Control MOSFET (Q1) Includes Zener Protection for ESD Ruggedness (> 6 kV Human Body Model)
- High Performance Trench Technology for Extremely Low On-Resistance
- SUPERSOT-6 Package Design Using Copper Lead Frame for Superior Thermal and Electrical Capabilities
- This is a Pb–Free and Halide Free Device

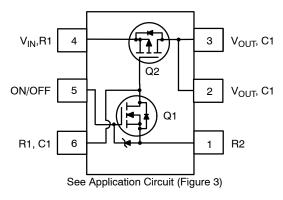


Figure 1.

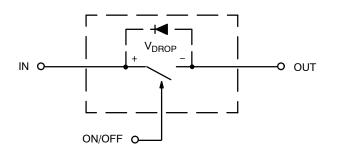


Figure 2. Equivalent Circuit



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TSOT-23-6 CASE 419BL

MARKING DIAGRAM



= Designates Space

= Pin One Dot

329 = Specific Device Code

&G = Date Code

&E &Y

&.

ORDERING INFORMATION

Device	Package	Shipping [†]		
FDC6329L	TSOT-23-6 (Pb-Free)	3000 / Tape & Reel		

+ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

⁼ Binary Calendar Year Coding Scheme

FDC6329L

ABSOLUTE MAXIMUM RATINGS $T_A = 25^{\circ}C$ unless otherwise noted

Symbol	mbol Parameter		Unit	
V _{IN}	Input Voltage Range (Note 1)	2.5–8	V	
V _{ON/OFF}	V _{ON/OFF} On/Off Voltage Range			
١L	Load Current – Continuous (Note 2)	2.5	Α	
	Load Current – Pulsed	10		
PD			W	
T _J , T _{STG}			°C	
ESD	Electrostatic Discharge Rating MIL–STD–883D Human Body Model (100 pF / 1500 Ω)	6	kV	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS T_{A} = 25°C unless otherwise noted

Symbol	Parameter	Value	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 2)	180	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case (Note 2)	60	°C/W

ELECTRICAL CHARACTERISTICS T_A = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARAC	TERISTICS					
I _{FL}	Forward Leakage Current	$V_{IN} = 8 \text{ V}, \text{ V}_{ON/OFF} = 0 \text{ V}$	-	-	1	μA
ON CHARACT	ERISTICS (Note 3)					
V _{DROP}	Conduction Voltage	V_{IN} = 5 V, $V_{ON/OFF}$ = 3.3 V, I_L = 2.8 A	-	0.12	0.2	V
		V_{IN} = 2.5 V, $V_{ON/OFF}$ = 3.3 V, I_L = 1.9 A	-	0.14	0.2	
R _{DS(on)}	Q ₂ – Static On–Resistance	$V_{GS} = -5 \text{ V}, \text{ I}_{D} = -2.5 \text{ A}$	-	0.047	0.07	Ω

105(01)				0.017	0.07	
		$V_{GS} = -2.5 \text{ V}, I_D = -2.0 \text{ A}$	-	0.073	0.105	
١L	Load Current	V_{DROP} = 0.2 V, V_{IN} = 5 V, $V_{ON/OFF}$ = 3.3 V	2.8	-	_	А
		V_{DROP} = 0.2 V, V_{IN} = 2.5 V, $V_{ON/OFF}$ = 3.3 V	1.9	-	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

1. Range of V_{in} can be up to 8 V, but R_1 and R_2 must be scaled such that V_{GS} of Q2 does not exceed –8 V. 2. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design. 3. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

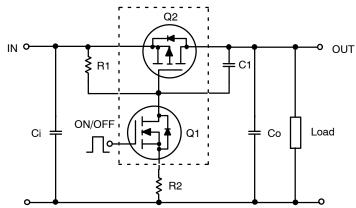


Figure 3. FDC6329L Load Switch Application

External Component Recommendation:

For applications where Co \leq 1 $\mu F.$ For slew rate control, select R2 in the range of 1k - 4.7 kΩ. For additional in-rush current control, $C1 \le 1000 \text{ pF}$ can be added.

Select R1 so that the R1/R2 ratio ranges from 10 - 100. R1 is required to turn Q2 off.

TYPICAL CHARACTERISTICS

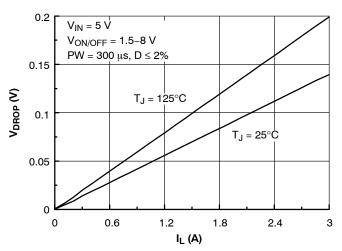
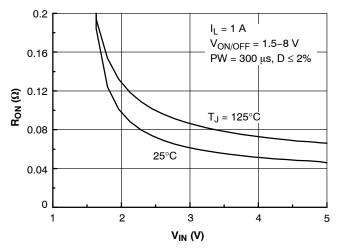
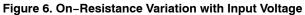


Figure 4. Conduction Voltage Drop Variation with Load Current





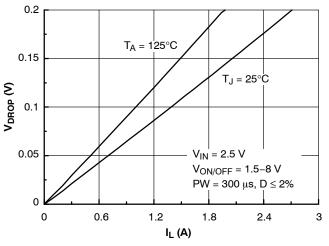
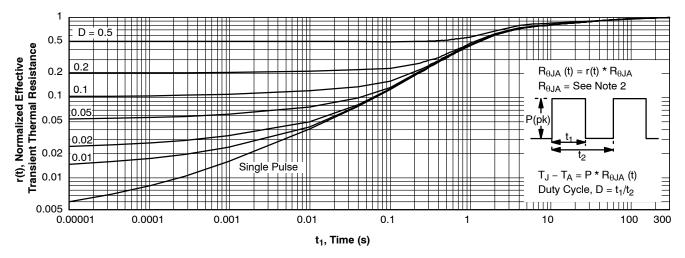
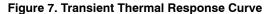


Figure 5. Conduction Voltage Drop Variation with Load Current

FDC6329L

TYPICAL CHARACTERISTICS (continued)

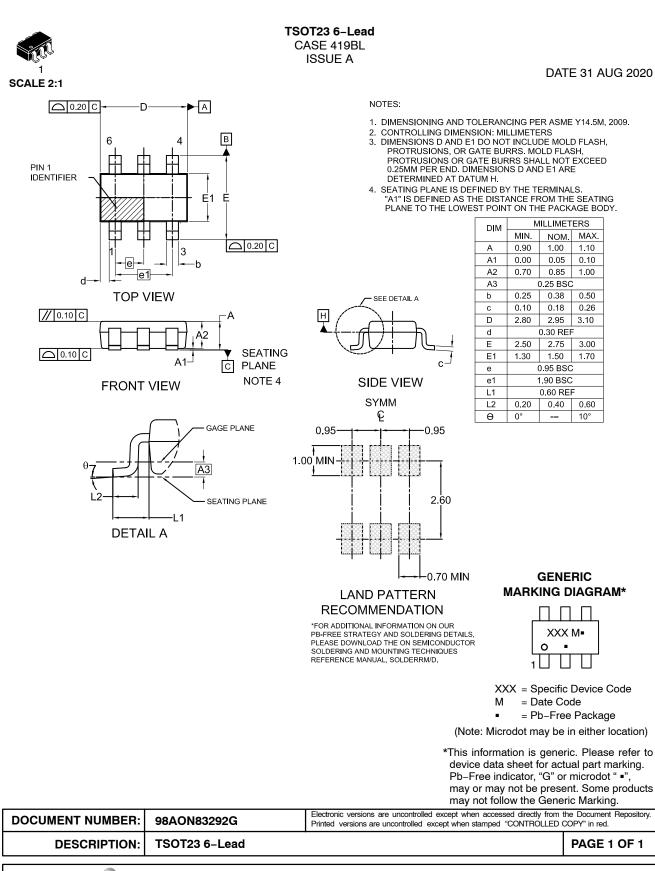




NOTE: Thermal characterization performed on the conditions described in Note 2. Transient thermal response will change depending on the circuit board design.

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